



**BRIGHTTEK**  
**BRIGHTTEK (EUROPE) LIMITED**

*Brighten Up The World With LED!*



ISO/TS 16949:2009



BS EN ISO 14001:2004



QC 080000 IECQ HSPM

## PRODUCT DATASHEET



- ▶ SuperFlux
- ▶ 3mm Round 4.0t
- ▶ True Green (525nm)

**NOG62P80S-30MA**



Release Date: 01 October 2022 Version: A1.0



### SuperFlux Series

**RoHS**  
Compliant



#### FEATURES:

- **Package:** THT Through Hole 4 Pins Package
- **Forward Current:** 30mA
- **Forward Voltage (typ.):** 3.1V
- **Luminous Flux (typ.):** 13.9lm@30mA
- **Colour:** True Green
- **Wavelength (typ.):** 525nm
- **Viewing angle:** 40°
- **Materials:**
  - Die: InGaN
  - Resin: Epoxy (Water Clear)
  - L/T Finish: Ag plated
- **Operating Temperature:** -30~+80°C
- **Storage Temperature:** -40~+100°C
- **Grouping parameters:**
  - Forward voltage
  - Luminous flux
  - Dominant wavelength
- **Soldering methods:** DIP Iron or Wave Soldering
- **Preconditioning:** acc. to JEDEC Level 3
- **Packing:** 60pcs/tube; 6300pcs/carton

#### APPLICATIONS:

- Decorative Lighting
- Indicator
- Commercial Lighting

## CHARACTERISTICS:

### Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	I <sub>F</sub>	35	mA
Peak Forward Current (Duty 1/10; width 10KHz)	I <sub>FP</sub>	100	mA
Reverse Current @5V	I <sub>R</sub>	10	μA
Power Dissipation	P <sub>D</sub>	119	mW
Electrostatic Discharge	ESD	500	V
Operating Temperature	T <sub>OPR</sub>	-30~+80	°C
Storage Temperature	T <sub>STG</sub>	-40~+100	°C

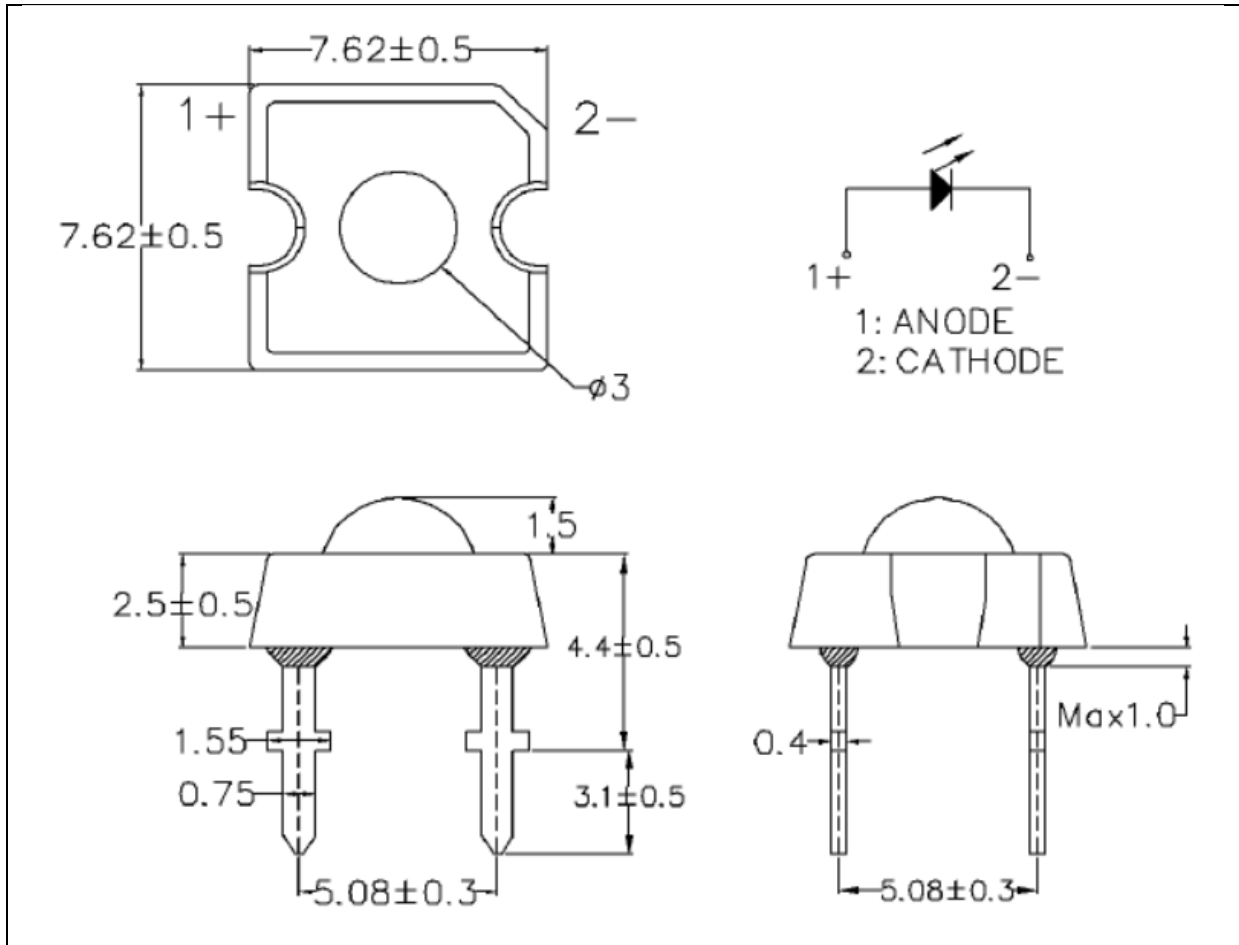
### Electrical & Optical Characteristics (Ta=25°C)

Parameter	Symbol	Values			Unit	Test Condition
		Min.	Typ.	Max.		
Forward Voltage	V <sub>F</sub>	2.8	---	3.4	V	I <sub>F</sub> =30mA
Luminous Flux	Φ <sub>V</sub>	8.2	13.9	---	lm	I <sub>F</sub> =30mA
Dominant Wavelength	λ <sub>D</sub>	---	525	---	nm	I <sub>F</sub> =30mA
Spectral Half Width	Δλ	---	20	---	nm	I <sub>F</sub> =30mA
Viewing Angle	2θ <sub>1/2</sub>	---	40	---	deg	I <sub>F</sub> =30mA

- Luminous intensity (I<sub>v</sub>) ±15%, Forward Voltage (V<sub>F</sub>) ±0.1V

## OUTLINE DIMENSION:

Package Dimension:



1. All dimensions are in millimetre (mm).
2. Tolerance  $\pm 0.2$ mm, unless otherwise noted.

**BINNING GROUPS:**


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 Forward Voltage Classifications ( $I_F = 30\text{mA}$ ):

Code	Min.	Max.	Unit
V2830	2.8	3.0	V
V3032	3.0	3.2	
V3234	3.2	3.4	

 Luminous Flux Classifications ( $I_F = 30\text{mA}$ ):

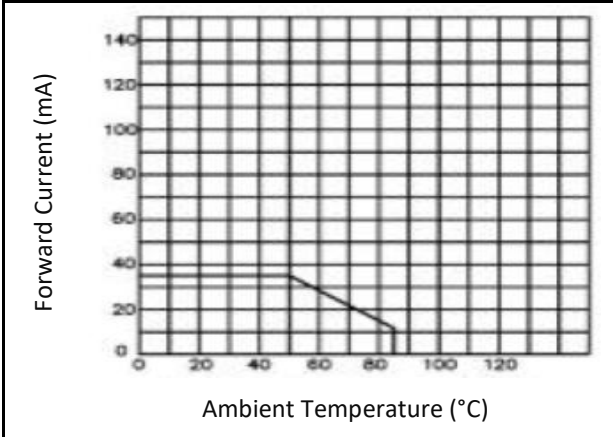
Code	Min.	Max.	Unit
F16	8.2	10.7	lm
F17	10.7	13.9	
F18	13.9	18.2	

 Dominant Wavelength Classifications ( $I_F = 30\text{mA}$ ):

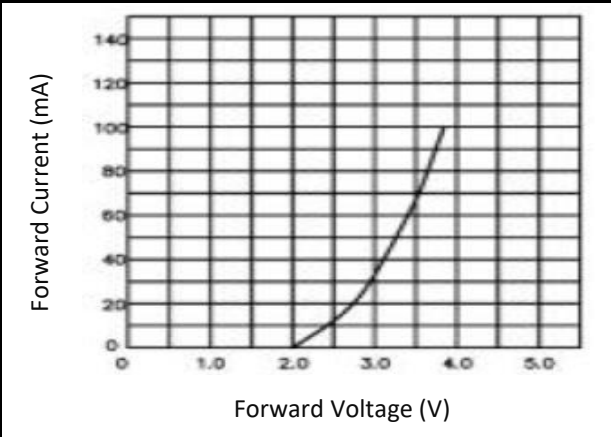
Code	Min.	Max.	Unit
1O	519	522	nm
1P	522	525	
1Q	525	528	
1R	528	531	

## ELECTRO-OPTICAL CHARACTERISTICS:

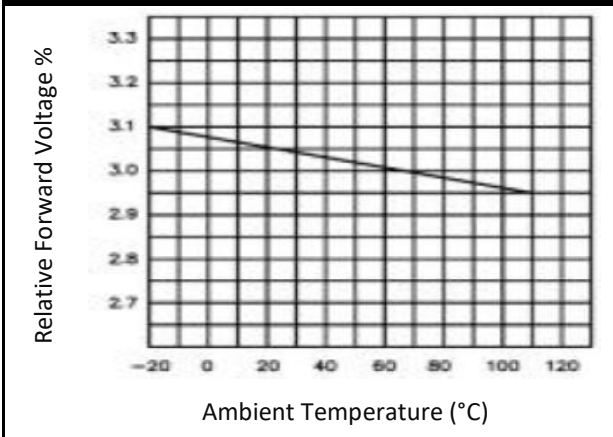
Forward Current v.s. Temperature



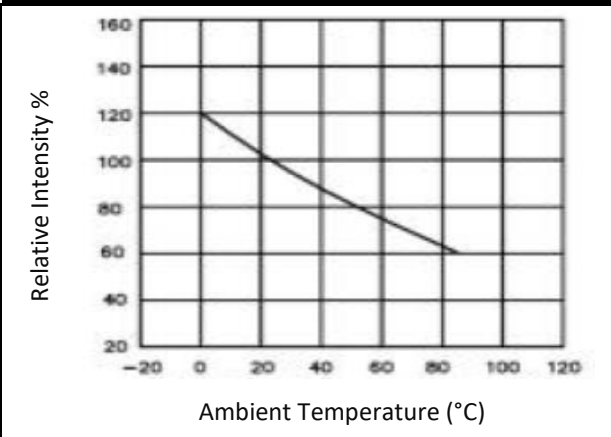
Forward Voltage v.s. Forward Current



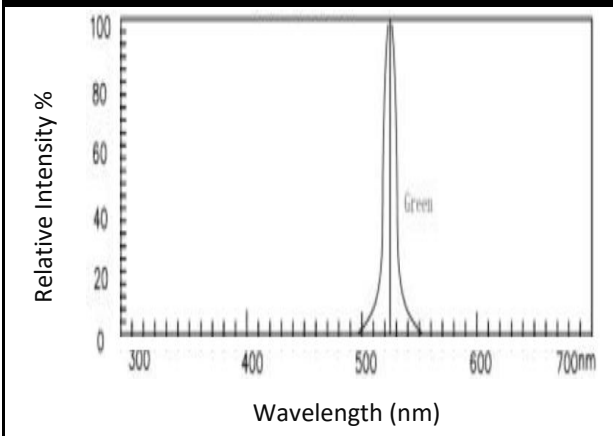
Relative Voltage v.s. Temperature



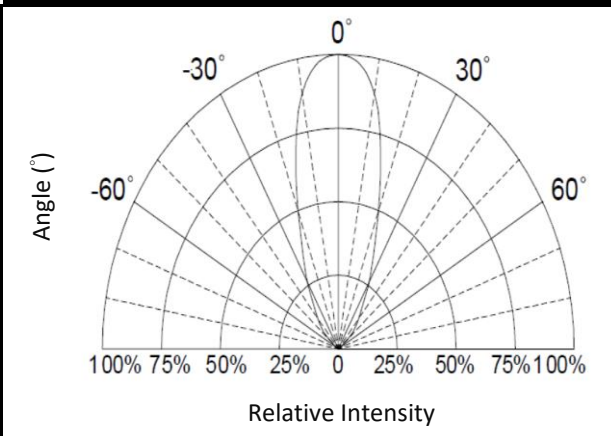
Relative Intensity v.s. Temperature



Relative Intensity v.s. Wavelength



Directive Radiation



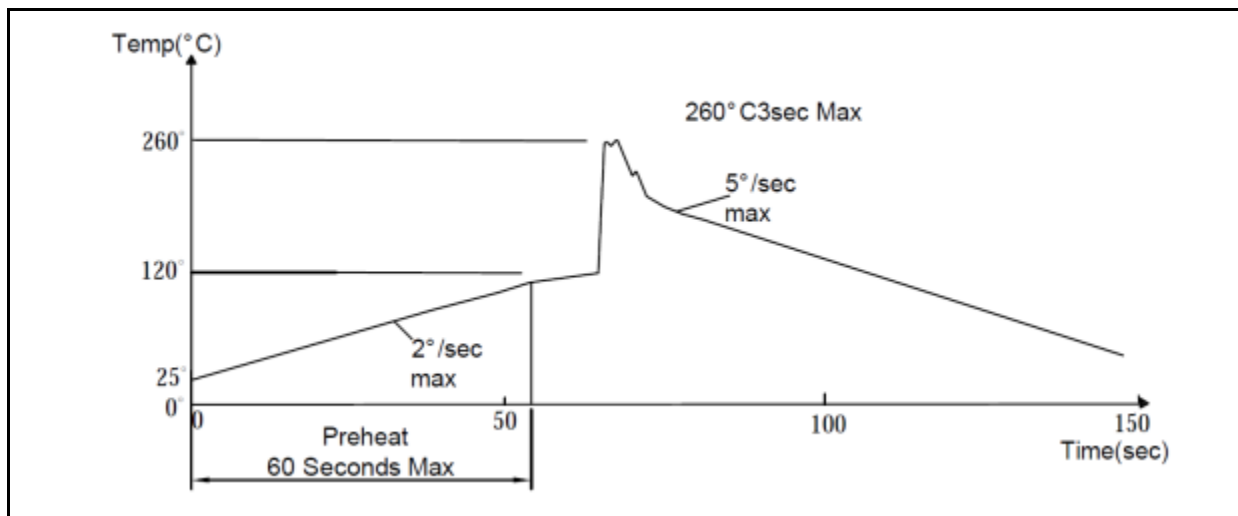
## RECOMMENDED SOLDERING PROFILE:

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### DIP Iron:

- Soldering Iron 30W Max.
- Temperature 350°C Max.
- Soldering Time 3 seconds Max. One time only.
- Distance 2mm Min. (from solder joint to body).

### Wave Soldering Profile:



### Note:

1. Maximum reflow soldering: 1 time.
2. Before, during, and after soldering, should not apply stress on the components and PCB board.
3. Recommended reflow temperature 240°C. The maximum soldering temperature should be limited to 260°C.

**PACKING SPECIFICATION:**

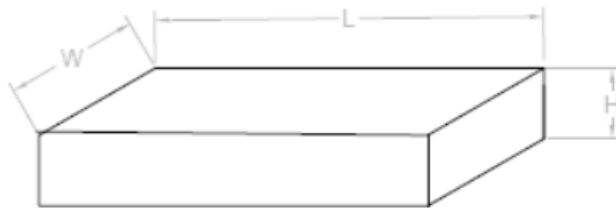
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Reel Dimension:

60pcs/tube; 105 tubes (6300pcs)/carton



SIZE : L X W X H 55cm X 22.5cm X 10cm



## PRECAUTIONS OF USE:

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### Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with desiccating agent <10% R.H. and apply baking before use.

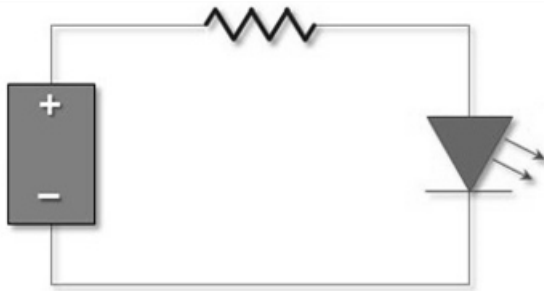
### Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

- 60±3°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

### Testing Circuit:



Must apply resistor(s) for protection (over current proof).

### Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

### ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrostatic glove is recommended when handling the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



**REVISION RECORD:**

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Version	Date	Summary of Revision
A1.0	01/10/2022	Datasheet set-up.